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A ging process of electrical contacts in granular m atter

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Abstract

The electrical resistance decay of a metallic granular packing has been measured as a function of time. This measurement gives information about the size of the conducting cluster formed by the well connected grains. Several regimes have been encountered. Chronologically, the rst one concerns the growth of the conducting cluster and is identied to belong to di usion processes through a stretched exponential behavior. The relaxation time is found to be simply related to the initial injected power. This regime is followed by a reorganisation process due to thermal dilatation. For the long term behavior of the decay, an aging process occurs and enhances the electrical contacts between grains through microsoldering.

1 Introduction

The structure of granularm aterials is characterized by arches that distribute the weight of the packing towards the edges of the vessel. This induces an anisotropic distribution of pressures at the points of contacts between grains. The electrical resistance R of one contact has been found to depend on the applied pressure, as a power law as dem onstrated by Hertz [1]. Any variations of the structure of the heap, whatever its nature (geometrical, chemical, electrical and mechanical), changes the contact network and in particular the overall electrical resistance, indeed in a way very sensitive to external perturbations [2, 3]. The information contained in R is also linked to the nature of the contacts. The surface of metallic grains may often be covered by an oxide which introduces som e sem iconducting properties to the contacts. This chem ical layer in fact constitutes a tunneling barrier to the current ow. Therefore a granular packing may be represented by a skeleton of electrical links between grains, each link being characterized by a certain electrical resistance determined by the pressure between beads (given by Hertz relation) [4, 5, 6]. The electrical resistance can thus be a tool which allows to explore arching pressure distribution without markedly changing the structure. Such a tool can be useful in probing stress in granular system as they are submitted to a shear for example. Moreover the study of the electrical properties of granular material can give information concerning large electrical com plex network.

Recent studies have shown that the electrical properties of metallic granular packings are complex, e.g. the voltage V across a sample is not univocally de ned by the injected current i. Indeed, current-voltage i V curves are nonlinear, sometimes singular or even discontinuous and exhibit memory elects [7, 8, 9]. A typical behavior is shown in Fig. 1. The role of the grain oxide layer has been pointed out to be responsible for the non-linear behavior of the electrical resistance with respect to the injected current [9]. M oreover taking into account the structure of the network and the nature of the contacts, the shape of the i V curves and its discontinuities (Fig.1) may be explained [9]. The sharp transitions, rst discovered by Calzecchi-Onesti [3], occur when the current reaches a certain value at which the resistance falls several orders of magnitude. This process is very similar to breakdowns in semiconducting devices [10]. This dielectric breakdown in plies high local electronic reactivity, increase in temperature and grain soldering. However, microsolderings between grains m ay occur before a Calzecchi-O nesti transition [11], just like nucleation sites are initiated by high concentration gradients at a rst order phase transition. Those solderings are non equilibrium, or irreversible processes thereby being the fundam ental cause for the hysteretic behavior found in i V curves of granular packing.

We have recorded the natural evolution of the electrical resistance of a lead beads heap versus time when a stable current ows through the system. A xed current is injected during 20 m in and the voltage is sampled every 0.2 s. D i erent current intensities have been injected in order to compare their e ect on the variations of the resistance with time. We emphasize that this situation di ers drastically from a classicali V curve measurement since in this latter case, the steps for increasing the injected current are very small and their succession very slow. The voltage has been found to decrease by about 30% depending on the value of the injected current.

The experimental set up is described in Sect.2. A discussion is found in sect.3. The conclusions are drawn in Sect.4.

2 Experimental set up

The experimental set up is simple but the dierent operations have to be performed with care because of the high sensitivity of the system to external perturbations. The lead beads have a mean diameter of 2:35 mm with a polydispersity of 2%. Energy D ispersive X-ray measurements have shown that the surface is made of a nanometric layer of lead oxide. About 14,000 beads have been stacked into a 50 50 40 mm³ plexiglas parallelepipedic vessel. The density of such a 3D packing is about 0.75 and is naturally near the close packing con guration. Electrical current leads are two lead rectangular plates placed on two opposite faces of the vessel and connected to a K eithley K 2400 current source [9]. The voltage V has been recorded at a 5 H z frequency on a computer. The whole system was placed in a climatized Faraday cage at 16C; no vibration was expected to occur during the experiments.

3 Results and interpretations

One of the typical i V behavior of the lead bead heap has been reported in Fig.1. D i erent features which have been discussed above are indicated in the gure, i.e. (i) hysteretic loops due to microsoldering, (ii) Calzechi-Onesti transition and (iii) a peak indicating the sensitivity of the electrical resistance to mechanical shocks.

Figure 2 presents R (t) results obtained for di erent injected currents between 10 and 65 m A. The resistance R has been obtained by dividing the measured voltage V by the injected current i. The di erent lines smoothly link the experimental data points. Symbols are placed every 50 points for trend emphasis.

The resistance decreases with time whatever the injected current is. This strongly resembles the behavior obtained in the case of the degradation of ultrathin oxide layers in presence of a electrical stress. Indeed such a behavior of the voltage can be found in ref. [10, 12]. Nanolayers of insulator stressed by a voltage are studied in those works. Leakage currents induce dam age to the insulator that allows m ore and m ore current to pass through. In the present case, the thin oxide layer that covers the beads is responsible for such a behavior.

The initial resistance di ers according to the injected current. The higher the injected current, the lower the electrical resistance. This matches with the non-linear behavior observed in the i V curves in Fig.1 where the slope is proportional to the di erential resistance. During the rst 2000 seconds of observation the resistance keeps on decreasing towards some saturating value.

The evolution of the resistance for an injected current of 65 m A is particular: a Calzeochi-O nesti transition occurs after 250 s, i.e. the resistance falls by one order of magnitude from 1800 to 35. In this case, two processes are noticed: (i) a slow process which governs the decay of the resistance with time and (ii) an avalanche process which induces the Calzeochi-O nesti transition (like a Zener breakdown).

In Fig.3, the voltage V normalized to the initial voltage $V_0 = V$ (t = 0) has been represented versus time in a sem i-log plot for four dierent currents (i < 50 m A), as indicated by the legend (a normalized voltage is equivalent to a normalized resistance). The decay amplitude is larger when the current is low, e.g. for i = 10 m A, the decay is about 25 %. Chronologically, the voltage

decay may be decomposed into three phases. (i) During the rst minute, the slope of the R-decay is about the same whatever the current value is. (ii) The curves obtained for i = 10 and 25 m A seem to regularly decrease. The curves obtained for i = 35 and 50 m A stabilise around $V=V_0 = 0.82$ during 1000 s before decreasing again. (iii) The slope of the curves are found to be the same from the 1000th second to the end of the experiment. We may conclude that various processes occur.

To sum up, the decay process goes as follows : (i) a primary voltage decrease during the rst m inutes, (ii) a tem portisation stage (due to the com – petition of two kinds of e ects), especially seen in curves i = 35 and 50 m A and (iii) a secondary decay phase.

In Fig.4, the data are analyzed during the st phase. A stretched exponential t,

$$\frac{V}{V_0} = (1 \ a) + ae^{p_{\frac{1}{t=}}}$$
 (1)

is found where a and are thing parameters (see inset). The square root exponent characterizes a di usion process as in crystal growth process [13, 14,15]. In the present case, this exponent can be interpreted as follows : The conduction of the current through the heap is thought to be done through a cluster of well' connected beads. If such privileged contacts exist, they shunt the remain of the packing. Recall that electrical stresses are concentrated along this cluster path. This means that any enhancement of other contacts allows the connected cluster to grow as in an avalanche process. This process is related to a di usion of stresses through the sam ple. Pennetta et al. show that such an avalanche-like propagation exists in sem iconductor integreation technology. Som e percolation models have been developped. However, the resistance decrease seems to be smoother than the one found in percolation models [16].

The cluster growth is limited by the size of the vessel; this can explain a saturation process. This isst stage is shortened as the current is increased. The caracteristic time depends on the value of the initial injected power $P = V_0 i$ as $/ P^{-1:18}$ (see inset Fig. 4). The exact value of the exponent is quite in uenced by the error bar on V_0 since this latter parameter is not very precise and is found to change very quickly near t = 0.

The tem porisation stage can be attributed to the increase of tem perature in the system. Indeed, a therm occupie has measured that the inner tem perature of the heap can increase by about 20 K, depending on the injected current value. This e ect is particularily noticeable for high currents, since m ore power has to be dissipated. The power dissipated (calculated at t = 2200 s) by the beads has been found to be 0.3, 1.9, 3.4 and 5.2 W for i = 10, 25, 35 and 50 m A respectively. Note that the local change in tem perature not only m odi es the nature of contacts, but also the structure of the network because of dilatation processes that m ay lead to a reorganization of system structure. Thism ay cause to a further increase in the resistance since m icrosolderings m ay be dam aged.

As seen before, the st decay seems to essentially concern the enhancem ent of the conductance due to the growth of the conducting network. On the other hand, the long term decay seems to be related to the enhancement of the contacts them selves. The thin insulating layer deteriorate with leakage current [10]. M icrosolderings occur and the global resistance decreases. The system can be easily reset to its initial resistance by a tap on the vessel.

4 Conclusions

The above evidences a di usion dynam ichas been evidenced. When a current is injected through granular packing, it takes much time (more than 2000 s) for the system to stabilize its resistance. First the resistance decreases due to a network e ect : the well connected cluster grows. Thus, because of the power dissipation, the tem perature change induces dilatation of certain beads : the resistance may increase according to the value of the power. Finally, contacts are enhanced by the slow deterioration of the oxide layer of beads.

To sum marize, the behavior of such material is thus completely dierent from a metallic bulk material. The perfect example is what happens in a lamp. The lamp lament has a resistance of about 50 for low current and at room temperature. When the current is switched on, the lamp produces light and heat. This change in temperature makes the electrical resistance increase. On the other hand, in the case of granular material, the opposite e ect occurs. When the current is rst set, the resistance is high. The heat, the aging and some Zenere ects a ect the resistance by decreasing it. Those e ects contribute to the growing of the connected cluster of beads.

Practically, as soon as som e m aterial presents weak links, electrical m easurements have to be carefully achieved. The injected current history and the injecting rate of the current are both seen to be very relevant param eters. Further theoretical works will be developed on the basis of those observations in order to model such complex electrical networks.

5 A cknow ledgem ents

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Figure Captions

Figure 1 Sketch of the i V behavior of a metallic granular material

Figure 2 Evolution of the electrical resistance of a lead beads heap with respect to time. The di erent curves have been obtained for several xed injected currents as indicated by the legend. The symbols are placed every 50 points

F igure 3 Norm alized voltage versus time obtained for dierent currents (see legend). One point out of 50 is indicated by a symbol; solid lines join the data points

F igure 4 Normalized voltage $V=V_0$ versus time. The symbols corresponds to diment injected currents (see legend) and take place one data point over 10. (inset) Relation between the relaxation time and the injected current

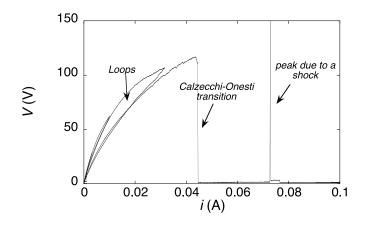


Figure 1: Dorbolo-JR 03-1539

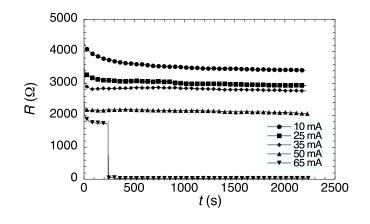


Figure 2: Dorbolo-JR 03-1539

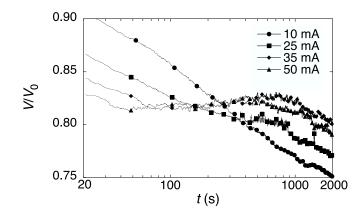


Figure 3: Dorbolo-JR 03-1539

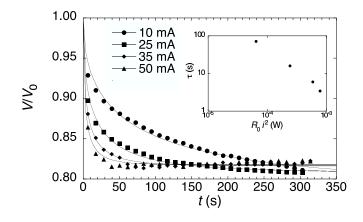


Figure 4: Dorbolo-JR 03-1539